

<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> <i>( Not for submission under 37 CFR 1.99)</i>	Application Number	10551305	
	Filing Date	2006-11-14	
	First Named Inventor	Nancy Dean	
	Art Unit	2823	
	Examiner Name	William D. Coleman	
	Attorney Docket Number	H0004275.84418 US2 - 4018	

**U.S.PATENTS**

Examiner Initial*	Cite No	Patent Number	Kind Code <sup>1</sup>	Issue Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear
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	2	6784535	B1	2004-08-31	Texas Instruments Incorporated	
	3	6815084	B1	2004-11-09	Honeywell International Inc.	
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	5	6828687	B2	2004-12-07	Advanced Semiconductor Engineering, Inc.	
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	7	6867367	B2	2005-03-15	Quantum Leap Packaging, Inc.	
	8	6882043	B2	2005-04-19	Intel Corporation	

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	9	6917431	B2	2005-07-12	Massachusetts Institute of Technology	
	10	6919504	B2	2005-07-19	3M Innovative Properties Company	
	11	6921970	B2	2005-07-26	Neomax Materials Co., Ltd.	
	12	6921971	B2	2005-07-26	Kyocera Corporation	
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	17	6984888	B2	2006-01-10	Chien-Min Sung	
	18	6987318	B2	2006-01-17	Chien-Min Sung	
	19	6989593	B2	2006-01-24	Broadcom Corporation	

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20	6992887	B2	2006-01-31	Visteon Global Technologies, Inc.	
21	7009289	B2	2006-03-07	Intel Corporation	
22	7019977	B2	2006-03-28	Intel Corporation	
23	7031162	B2	2006-04-18	International Business Machines Corporation	
24	7035106	B2	2006-04-25	Samsung Electronics Co., Ltd.	
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28	7081375	B2	2006-07-25	Samsung Electronics Co., Ltd.	
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34	7005737	B2	2006-02-28	Broadcom Corporation	
35	7009307	B1	2006-03-07	Altera Corporation	
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37	7023089	B1	2006-04-04	Intel Corporation	
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39	7038316	B2	2006-05-02	Intel Corporation	
40	7044196	B2	2006-05-16	Cooligy, Inc.	
41	7044199	B2	2006-05-16	Thermal Corp.	

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42	7046870	B2	2006-05-16	Samsung Electro-Mechanics Co., Ltd.	
43	7069645	B2	2006-07-04	NGK Insulators, Ltd.	
44	7084494	B2	2006-08-01	Texas Instruments Incorporated	
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46	7090001	B2	2006-08-15	Cooligy, Inc.	
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50	4810563		1989-03-07	The Bergquist Company	

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#### U.S.PATENT APPLICATION PUBLICATIONS

Examiner Initial*	Cite No	Publication Number	Kind Code <sup>1</sup>	Publication Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear

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	1	20020190361	A1	2002-12-19	Sam Z. Zhao, et al.	
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#### FOREIGN PATENT DOCUMENTS

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<sup>4</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>5</sup> Applicant is to place a check mark here if English language translation is attached.